

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	167	hongo-akihisa.in.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/28 16:23
L3	14	morisawa-shinya.in.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/28 16:23
L4	917	plat\$4 same etch\$4 same (copper or Cu or silver) same (peripheral or edge or circumference)	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/28 16:28
L5	539	clean\$4 same (copper or Cu) same (peripheral or edge or circumference)	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/28 16:25
L6	293	clean\$4 same etch\$4 same (copper or Cu) same (peripheral or edge or circumference)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/28 16:26
L7	855	plat\$4 same etch\$4 same (copper or Cu) same (peripheral or edge or circumference)	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/28 16:26
L8	25	etch\$4 same (copper or Cu or silver or Au or gold) same (peripheral or edge or circumference) same (residues or contaminations)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/28 16:29
L9	2933	etch\$4 and (copper or Cu or silver or Au or gold) and (peripheral or edge or circumference) and (residues or contaminations)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/28 16:29
L10	827	@py<="2000" and 9	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/28 16:30
L11	415	10 and semiconductor	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/28 16:30